ASU board: PCB production and testings

GRPC-SDHCAL Review Meeting

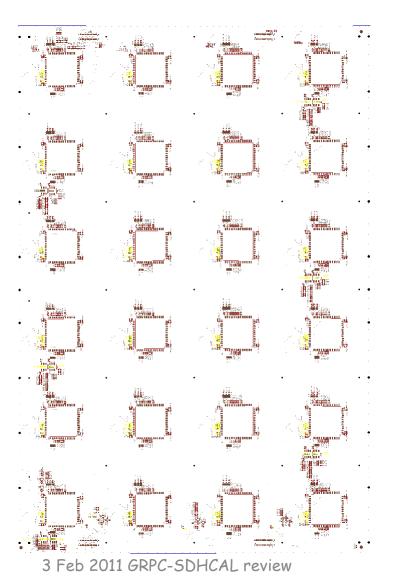
Presentation outline

- Active Sensor Unit electronic board
 - -quick reminder
 - board functional decomposition
 - testing issues
- square meter (m2) board
 - reminder
 - integration scenario
- m2 boards production: provisional plan

The ASU board: reminder



- 2 main functions:
 - interface
 - front-end electronics <-> GRPC
 - functional support for 24
 HARDROCs
- production outsourcing:
 - PCB fabrication (sample production checks)
 - board assembly (components soldering: visual inspection)
- functional checks performed at IPNL



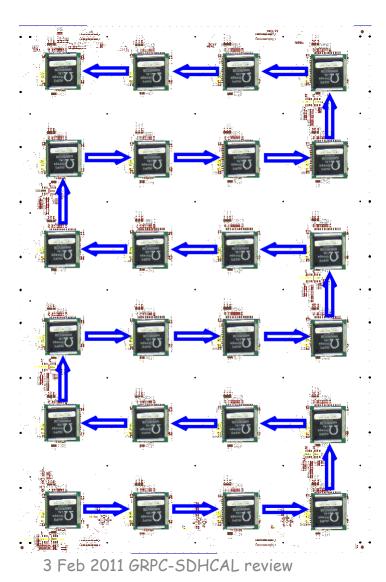
HARDROC (HR)

- 24 asics/board
- all asics daisy chained
- only active device
- input pads
 - 64 pads/HARDROC (1 cm2)
 - board BOTTOM side
- interconnections
 - 4x 80pin smd connectors
 - pwr supply + HR ctrl data
- board configurability
 - 3 ASU board configurations
 - 310 closed straps (362 total)
 - 22 matched lines terminations



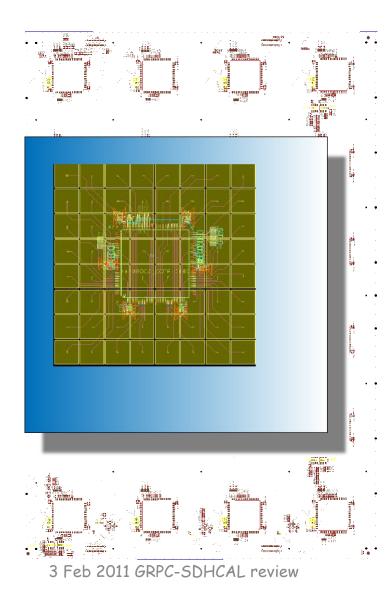
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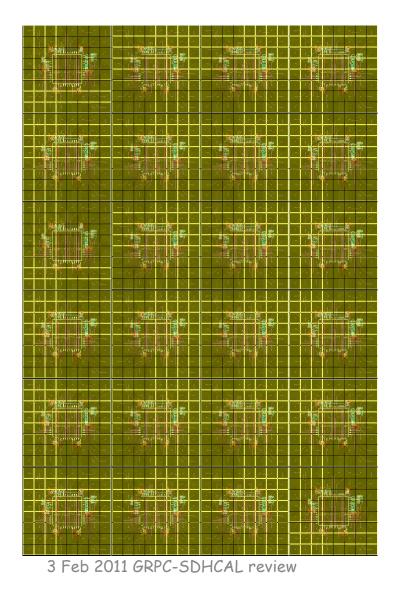


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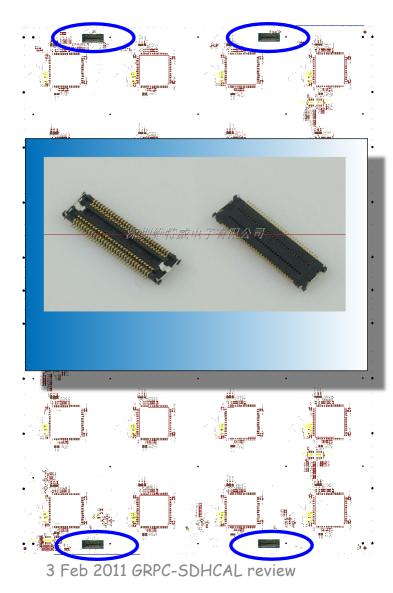
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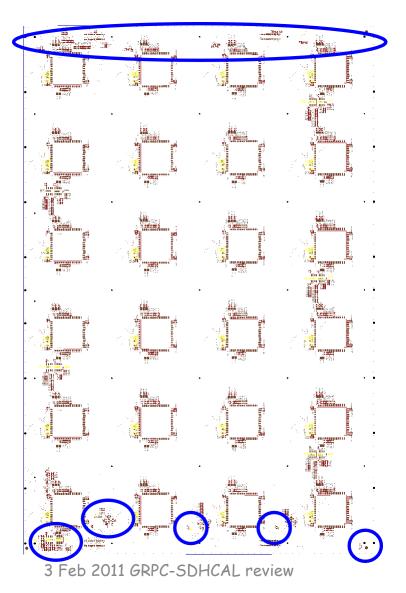
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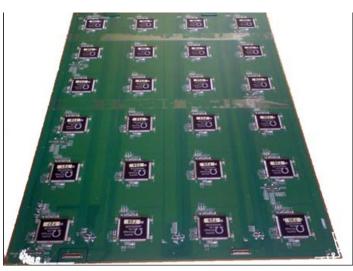
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ASU board: 3 configurations



only 2 cfg used for m3 integration

- "production" cfg only used for single board testing
- "slab 1st" + "slab 2nd" used in slab integration
- different configurations made by straps and passive components
- test strategy:
 - all configurations need to be checked

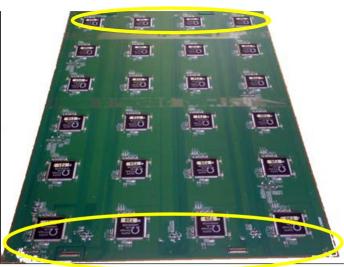




functional test at each integration stage:

- the "production" board must pass a functional test
 - boards are reconfigured either as "slab 1st" or "slab 2nd"
- the slab is functionally tested
 - 3 slabs are integrated in a m2 board
- the m2 board is functionally tested before integration with the GRPC
 - the m2 is integrated into his cassette
- the integrated cassette must pass a complete functional test
- two separate test benches will be used
- functional tests: GO / NO GO strategy

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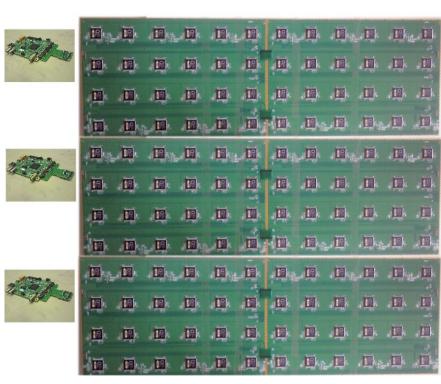




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board/slab/m2 test benches

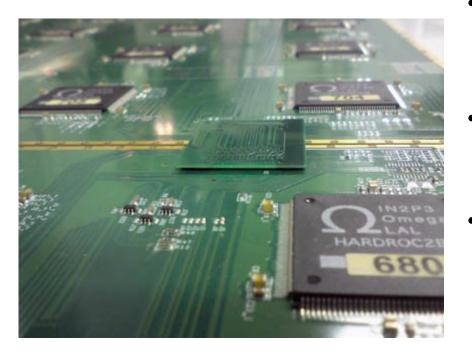


- two separate test benches:
 - 1 pc with XDAQ
 - DIF + DIF-ASU boards
 - DAQ software
 - GO / NO GO strategy
 - no debugging
 - only functional tests:
 - power consumption
 - HR slow control
 - pedestal acquisition runs
 - HR calibration feature (CTEST)

goals:

- checking all functionalities/connections
- electronics checks at each integration step

m2 integration scenario



- components:
 - 6x ASU boards
 - 6x ASU-ASU interlinks
- boards and interlinks already configured and tested before integration
- integration procedure:
 - ASU boards soldered together by the mean of copper gasket
 - m2 board tested as a whole
- goal: one m2 board/day

m2 boards mass production

- boards' needings for the 40 layers prototype:
 - 240x ASU + 240 ASU-ASU + 120 DIF-ASU
- production run is:
 - 20(pre-series available) + 280(<8weeks availability) ASU
 - 330(PCB available) ASU-ASU
 - 150(PCB available) DIF-ASU
- status:
 - launching of the 280 ASU series still pending
 - testing of prototypes+preseries shows HR mortality (10%)
 - plan: accelerated stress testing of HR production sample
 - DIF-ASU and ASU-ASU preseries (assembly) launched
- provisional planning:
 - AST to assess infant mortality of HARDROCs
 - launching of the 280 ASU series (PCB: availability of the 1st lot is 4weeks)
 - launching of the DIF-ASU and ASU-ASU series (assembly)
 - testing of the DIF-ASU and ASU-ASU preseries and series
 - ASU boards mass production (producer throughput to be assessed)
 - start m2 boards integration and test (1m2/day)